



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Qualification Report for PCN# 20110808000
C10 Offload to CFAB
Information Only**

Dear Customer:

Texas Instruments is pleased to announce the completion of qualification testing for the product change described in PCN# 20110808000. The details of the qualification results are included in the following pages and are being forwarded to you in response to your inquiry about this PCN.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services
Phone: +1(214) 480-6037
Fax: +1(214) 480-6659



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Qualification Report For # 20110808000 C10 Offload to CFAB

Qualification Data: 11/14/2012

This qualification has been specifically developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications.

Qual Vehicle: SN74AVC16T245DGGR

Wafer Fab Site:	CFAB	Metallization:	Ti/TiN/AlCu.5%/TiN
Wafer Fab Process:	33C10	Wafer Diameter:	200mm
		Passivation	10KACN

Qualification: ☐ Plan ☒ **Test Results**

Reliability Test	Conditions	Sample Size/Fails		
		Lot#1	Lot#2	Lot#3
High Temp Operating Life	150C (300 Hrs)	77/0	77/0	77/0
Electrical Characterization	-	77/0	77/0	77/0
High Temp. Storage Bake	170C (168, 420 Hrs)	77/0	77/0	77/0
**Biased HAST	130C/85%RH (96 Hrs)	77/0	77/0	77/0
**Autoclave 121C	121C, (96 Hrs)	77/0	77/0	77/0
**T/C -65C/150C	-65C/+150C (500 Cycles)	77/0	77/0	77/0
ESD HBM	2000V	3/0	3/0	3/0
ESD CDM	500V	3/0	3/0	3/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Wafer level Reliability	Approved by TDQRE	Pass	Pass	Pass
Wafer Fab MQ	Per site spec	Pass	Pass	Pass
Assembly / Test MQ	(per mfg. Site specification)	Pass	Pass	Pass
Latch-up	(per JESD78)	6/0	6/0	6/0
X-ray	(top side only)	5/0	5/0	5/0
Moisture Sensitivity	(level 1 @ 260C peak +5/-0C)	12/0	-	-

**Preconditioning: Level 1@260C

Qual Vehicle: TS3L500AERHUR

Wafer Fab Site:	CFAB	Metallization:	Ti/TiN/NCu0.5%/TiN
Wafer Fab Process:	33C10	Wafer Diameter:	200mm
		Passivation:	10KACN

Qualification: ☐ Plan ☒ **Test Results**

Reliability Test	Conditions	Sample Size/Fails		
		Lot#1	Lot#2	Lot#3
High Temp Operating Life	150C (300 Hrs)	77/0	77/0	77/0
Electrical Characterization	-	Pass	Pass	Pass
High Temp. Storage Bake	170C (168, 420 Hrs)	77/0	77/0	77/0
**Biased HAST	130C/85%RH (96 Hrs)	77/0	77/0	77/0
**Autoclave 121C	121C, (96 Hrs)	77/0	77/0	77/0
**T/C -65C/150C	-65C/+150C (500 Cycles)	77/0	77/0	77/0
ESD HBM	2000V	3/0	3/0	3/0

ESD CDM		500V	3/0	3/0	3/0
Bond Strength		76 ball bonds, min. 3 units	76/0	76/0	76/0
Wafer level Reliability		Approved by TDQRE	Pass	Pass	Pass
Latch-up		(per JESD78)	6/0	6/0	6/0
Manufacturability (Assembly)		(per mfg. Site specification)	Pass	Pass	Pass
Wafer Fab MQ		(per mfg. Site specification)	Pass	Pass	Pass
X-ray		(top side only)	5/0	5/0	5/0
Moisture Sensitivity		(level 1 @ 260C peak +5/-0C)	12/0	12/0	12/0
**Preconditioning: Level 1@260C					
Qual Vehicle: TXS0102DQE					
Wafer Fab Site:	CFAB	Metallization:	Ti/TiN/NCu0.5%/TiN		
Wafer Fab Process:	33C10	Wafer Diameter:	200mm		
		Passivation:	10KACN		
Qualification: <input type="checkbox"/> Plan <input checked="" type="checkbox"/> Test Results					
Reliability Test		Conditions	Sample Size/Fails		
			Lot#1	Lot#2	Lot#3
High Temp Operating Life		150C (300 Hrs)	77/0	-	-
**Biased HAST		130C/85%RH (96 Hrs)	77/0	-	-
**Autoclave 121C		121C, (96 Hrs)	77/0	77/0	77/0
**T/C -65C/150C		-65C/+150C (500 Cycles)	77/0	77/0	77/0
ESD HBM		2000V	3/0	-	-
ESD CDM		500V	3/0	-	-
Bond Strength		76 ball bonds, min. 3 units	76/0	76/0	76/0
Latch-up		(per JESD78)	6/0	-	-
Manufacturability (Assembly)		(per mfg. Site specification)	Pass	Pass	Pass
Wafer Fab MQ		(per mfg. Site specification)	Pass	-	-
X-ray		(top side only)	5/0	5/0	5/0
Moisture Sensitivity		(level 1 @ 260C peak +5/-0C)	12/0	12/0	12/0
**Preconditioning: Level 1@260C					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com